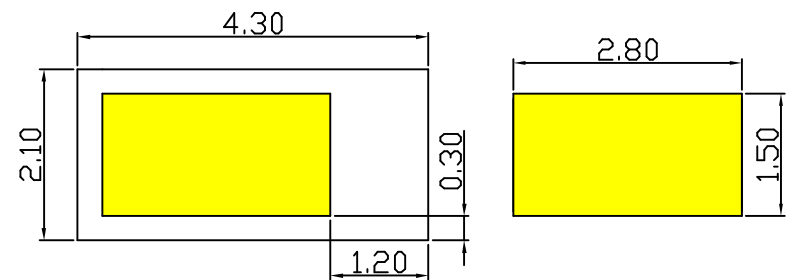
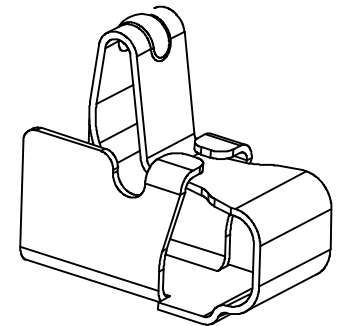
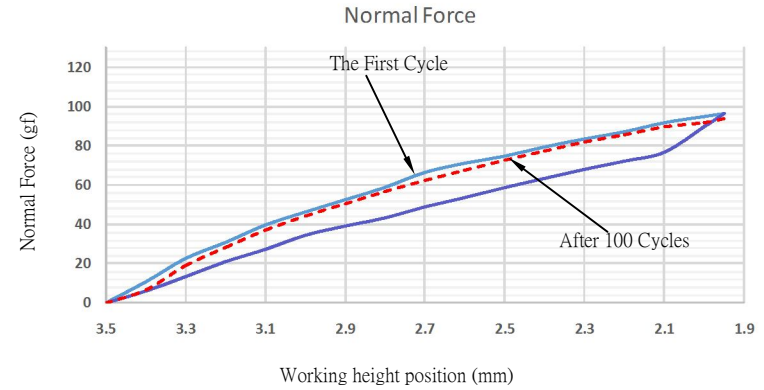
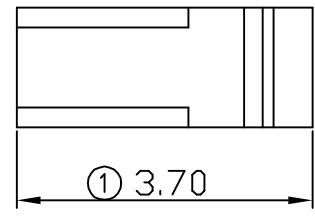
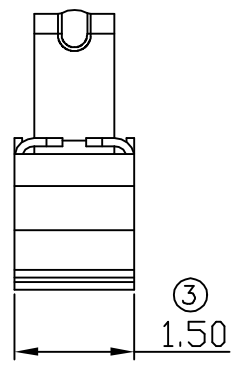
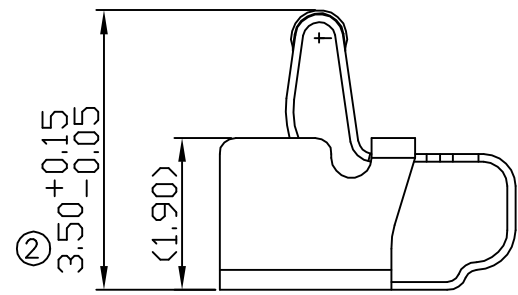
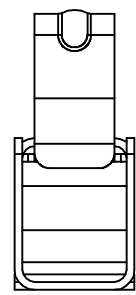
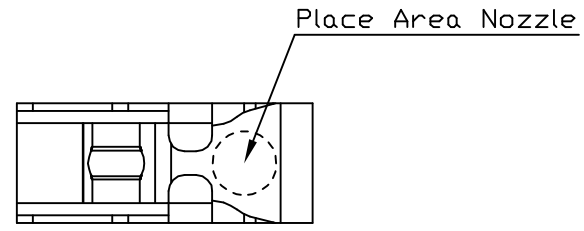


A
B
C
D
E
F



RECOMMENDED SOLDERING PCB LAYOUT

TOLERANCE(.XX±0.05)



- Note:
1. Material: Titanium copper Thickness 0.10mm
 2. Electroplate:
 - Gold Flash on contact area
 - Gold Flash on solder area
 - Nickel underplating over all
 3. Electrical Characteristics:
 - 3-1 Current Voltage: 12V
 - 3-2 Current Rate: 3A
 - 3-3 Contact Resistance: Normal Compression <30mΩ
 4. Working Height of Application: 1.95~3.00 mm
 5. Spring Force Tolerance is ±20gf
 6. Operating Temperature: -20℃~+85℃

00	05/15-'19	Design creation			
REV	Date	Description			
DRAFT	Lydia Tsai	DATE	05/15-'19	RoHS Compatible	
CHECKER	Justin Wu	DATE	05/15-'19		
APPROVAL	Jacky Lin	DATE	05/02-'16		
		SHEET	1-2	SCALE	Not to scale
		UNIT	mm		



TOLERANCE/CLASS			
RANGE(mm)	1	2	3
≤30	±0.10	0.15	0.20
30<- ≤120	±0.15	0.20	0.30
120<- ≤300	±0.20	0.30	0.50
300<	±0.30	0.50	0.80
ANGLES	±2.5°		

EMI STOP CORP.
 EMI STOP
 EMISTOP QTT-35A2G CUS P/N